

Preliminary

iEP-9040E, iEP-9030E, iEP-9042E, iEP-9032E

Compact Edge AIoT Platform



iEP-9040E,
iEP-9030E

iEP-9042E,
iEP-9032E

KEY FEATURES

iEP-9040E:

- Intel® Core™ Processors (Series 2) with R680E Chipset

iEP-9030E:

- Intel® 14th Gen Core™ Processors with R680E Chipset

iEP-9042E:

- Intel® Core™ Processors (Series 2) with H610 Chipset

iEP-9032E:

- Intel® 14th Gen Core™ Processors with H610 Chipset

iEP-9040E, iEP-9030E:

- 2 x 262-pin DDR5 SO-DIMM up to 96GB (48GB per DIMM)
- 2 x M.2 Key M, 2 x M.2 Key B, 1 x M.2 Key E
- 6 x USB 3.2 Gen2x1, 6 x COM, 4 x SATA3, 8 x DI, 8 x DO
- 5 x Intel 2.5G LAN (2 support PoE, LAN1 supports vPro)
- 1 x Displayport, 1 x HDMI 2.0b, 1 x VGA,
- Support Wireless Time-Sensitive Networking (WTSN)

iEP-9042E, iEP-9032E:

- 2 x 262-pin DDR5 SO-DIMM up to 96GB (48GB per DIMM)
- 1 x M.2 Key M, 2 x M.2 Key B, 1 x M.2 Key E
- 4 x USB 3.2 Gen2x1, 2 x USB 2.0, 6 x COM, 4 x SATA3, 8 x DI, 8 x DO
- 4 x Intel 2.5G LAN (2 support PoE)
- 1 x Displayport, 1 x HDMI 2.0b, 1 x VGA

SPECIFICATIONS

Processor System	iEP-9040E/ iEP-9030E	iEP-9042E/ iEP-9032E
CPU (iEP-9040E, iEP-9042E)	Intel® Core™ Processors (Series 2)	
CPU (iEP-9030E, iEP-9032E)	Intel® 14th Gen Core™ Processors	
Chipset	Intel® R680E	Intel® H610
Socket	LGA 1700	

Memory	
Technology	Dual Channel DDR5 5600MHz (ECC memory supported by R680E + Selected CPU)
Capacity	96 GB (48 GB per DIMM)
Socket	2 x 262-pin SO-DIMM

Graphics	
Controller	Intel® UHD Graphics
DisplayPort	DisplayPort 1.4a, DP++ Max resolution up to 4096x2160@60Hz
HDMI	HDMI 2.0b Max resolution up to 4096x2160@60Hz
VGA	Max resolution up to 1920x1200@60Hz

Audio	
Interface	Realtek ALC897, High Definition Audio.

Expansion Slot	
RF& Antenna	8 x SMA connector hole reserved
M.2 (iEP-9040E, iEP-9030E)	1 x M.2 (Key E, 2230) with CNVi/PCIe Gen3 x1 and USB2.0 for Wi-Fi/BT module 1 x M.2 (Key B1, 2280/3042/3052) with PCIe Gen3 x1 / USB3.2 Gen1x1 and USB2.0 for 4G / 5G 1 x M.2 (Key B2, 3042/3052) with PCIe Gen3 x1 / USB3.2 Gen1x1 and USB2.0 for 4G / 5G

Expansion Slot	iEP-9040E/ iEP-9030E	iEP-9042E/ iEP-9032E
M.2 (iEP-9042E, iEP-9032E)	1 x M.2 (Key E, 2230) with CNVi/PCIe Gen3 x1 and USB2.0 for Wi-Fi/BT module 1 x M.2 (Key B1, 2280/3042/3052) with PCIe Gen3 x1 and USB2.0 for 4G / 5G 1 x M.2 (Key B2, 3042/3052) with PCIe Gen3 x1 and USB2.0 for 4G / 5G	
SIM Socket	2 x Nano SIM Card slots (2 connected to M.2 Key B)	

Ethernet

Controller/ Speed (9040E, 9030E)	3 x Intel® i226IT (LAN1 vPro Support)
Controller/ Speed (9042E, 9032E)	2 x Intel® i226IT
Controller/ Speed	2 x Intel® i226IT (PoE Support, each port supports IEEE802.3A TPoE, PoE output max. 30W/single port or 30W/two ports shared)
Connector (9040E, 9030E)	5 x RJ45
Connector (9042E, 9032E)	4 x RJ45

Storage

M.2 (9040E, 9030E)	1 x M.2 (Key M1, 2242/2260/2280) with Gen4 x4 ofr NVMe SSD 1 x M.2 (Key M2, 2242/2280/22110/25110) with Gen3 x4 ofr NVMe SSD
M.2 (9042E, 9032E)	1 x M.2 (Key M, 2242/2280/22110/25110) with Gen3 x1 for NVMe SSD
SATA (9040E, 9030E)	4 x SATA3 (6Gb/s), support RAID 0/1/5/10
SATA (9042E, 9032E)	4 x SATA3 (6Gb/s)
SATA	4 x 2.5" HDD/SSD Tray (Default 1 piece)
C-Flash (Option)	1 x Type II socket (Shared with SATA3)

Front I/O

DisplayPort	1
HDMI	1
VGA	1
Ethernet	5 x Intel 2.5G LAN
USB	6 x USB 3.2 Gen2x1, 1 x USB2.0 internal connector w/ lock function 4 x Intel 2.5G LAN 4 x USB 3.2 Gen2x1, 2 x USB 2.0, 1 x USB2.0 internal connector w/ lock function
Audio	1 x Mic-in, 1 x Line-out
COM	4 x RS232/422/485 (COM1, COM2- optional Card w/ Isolation Protection, COM5- Isolation Protection, COM6) 2 x RS232 (COM3, COM4)
DIO	8 DI/8 DOs

Watchdog Timer

Output Interval	From Super I/O to drag RESETCON# 256 Segments, 0, 1, 2, ...255sec
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Power Requirements

Input PWR	9V~36V VDC with Ignition control and remote power on/off switch. 80V Surge Protection, OVP, UVP, OCP and reverse protection for MB Power Input. Ignition Power Input w/ 13-mode condition.
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Environment

Operating Temperature	35W CPU: -40°C~75°C (-40°F~167°F) (Only for iEP-9030E Series) 45W~65W CPU: -40°C~50°C (-40°F~122°F) (w/ air flow 0.5~0.8 m/s)
Storage Temperature	-40°C~85°C (-40°F~185°F)
Humidity	~95% @ 40°C (non-condensing)
Shock	Operating: 50G, half sine 11ms duration with SSD (More stringent than MIL-STD-810H)
Vibration	Operating: 5 Grms, 5-500 Hz, 3 axes with SSD (More stringent than MIL-STD-810H)
ESD	Contact +/-4kV, Air +/-8kV
EMC	EN61000-6-4/-2, CE & FCC Class A
Safety	LVD

Mechanical

Construction	Aluminum heatsink + Metal chassis
Mounting	Desk Mount
Dimensions	201.7mm (W) x 244.8mm (D) x 109.5mm (H) (7.94" x 9.64" x 4.31")
Net Weight	6.5kg

Others

OS Support	Windows 10 & Linux
TPM	TPM 2.0
Real-Time Enablement	TSN, TCC support under YOCTO

The specification is subject to change without notice. Any configuration other than original product specification is not guaranteed.